Filename: PMP4502REVB_bom.xls

Date: 02/09/2009

# PMP4502REVB BOM

| COUNT | RefDes | Value | Description | SIZE | Part Number | MFR | AREA |
|---|---|---|---|---|---|---|---|
| 1 | C1 | 470p | Capacitor, Ceramic, 50V, [temp], [tol] | 0603 | std | std | 5650 |
| 1 | C2 | 220n | Capacitor, Ceramic, 16V, [temp], [tol] | 0603 | std | std | 5650 |
| 1 | C3 | 10p | Capacitor, Ceramic, 50V, [temp], [tol] | 0603 | std | std | 5650 |
| 1 | C4 | 15n | Capacitor, Ceramic, 50V, [temp], [tol] | 0603 | std | std | 5650 |
| 1 | C5 | 100n | Capacitor, Ceramic, 50V, [temp], [tol] | 0603 | std | std | 5650 |
| 1 | C7 | 1u | Capacitor, Ceramic, 16V, X7R, 20% | 0603 | std | std | 5650 |
| 2 | C8 | 4.7uF | Capacitor, Ceramic, 50V, X7R | 1210 | Std | Kemet, Murata, AVX | 83,600 |
| 1 | C9 | 330p | Capacitor, Ceramic, vvV, [temp], [tol] | 0603 | std | std | 5650 |
| | C10 | 4.7uF | Capacitor, Ceramic, 50V, X7R | 1210 | Std | Kemet, Murata, AVX | 83,600 |
| 2 | C11 | 2.2uF | Capacitor, Ceramic, 100V, X7R, 20% | 1210 | Std | std | 83,600 |
| | C12 | 2.2uF | Capacitor, Ceramic, 100V, X7R, 20% | 1210 | Std | std | 83,600 |
| 2 | C13 | 56u | Capacitor, Aluminum Electrolytic, 63V | 0.315 inch | 63ZL56M8x11.5 | Rubycon | 94,025 |
| | C14 | 56u | Capacitor, Aluminum Electrolytic, 63V | 0.315 inch | 63ZL56M8x11.5 | Rubycon | 94,025 |
| 1 | C27 | 220uF | Capacitor, Aluminum, 220uF, 50V, 0.042 Ohms | 0.315 | 050ZL220uF20%10X16 | Rubycon | 94,025 |
| 1 | D1 | MBRS360 | Diode, 3A, 60V | SMC | MBRS460 | Onsemi | 95000 |
| 2 | J1 | D120/2DS | Terminal Block, 2-pin, 15-A, 5.1mm | 0.40 x 0.35 inch | D120/2DS | OST | 141600 |
| | J2 | D120/2DS | Terminal Block, 2-pin, 15-A, 5.1mm | 0.40 x 0.35 inch | D120/2DS | OST | 141600 |
| 1 | L1 | 68u | Inductor, SMT, 3.4-A, 91.3-milliohm | 0.484 x 0.484 inch | MSS1278-683MLD | Coilcraft | 269,336 |
| 1 | Q1 | Si7308DN | MOSFET, Fast Switching, NChan, 60V, 6A, 59millohm | PWRPAK 1212 | Si7110DN | Vishay | 27200 |
| 1 | R1 | 249k | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R2 | 165k | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R3 | 2.00k | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R5 | 137k | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R6 | 10 | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R7 | 0 | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R9 | 49.9 | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R10 | 1k | Resistor, Chip, 1/16W, 1% | 0603 | std | std | 9100 |
| 1 | R11 | 0.047 | Resistor, Chip, 1W, 5% | 2512 | std | STD | 35100 |
| 3 | TP1 | 5011 | Test Point, Black, Thru Hole | 0.125 x 0.125 inch | 5011 | Keystone | |
| 2 | TP2 | 5010 | Test Point, Red, Thru Hole | 0.125 x 0.125 inch | 5010 | Keystone | |
| 1 | TP4 | 5002 | Test Point, White, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5002 | Keystone | 10 |
| 1 | TP5 | 5002 | Test Point, White, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5002 | Keystone | 10 |
| 1 | TP7 | 5000 | Test Point, Red, Thru Hole Color Keyed | 0.100 x 0.100 inch | 5000 | Keystone | 10 |
| | TP8 | 5011 | Test Point, Black, Thru Hole | 0.125 x 0.125 inch | 5011 | Keystone | |
| | TP10 | 5010 | Test Point, Red, Thru Hole | 0.125 x 0.125 inch | 5010 | Keystone | |
| | TP11 | 5011 | Test Point, Black, Thru Hole | 0.125 x 0.125 inch | 5011 | Keystone | |
| 1 | U1 | TPS40210DGQ | IC, Low Cost Non-Synchronous Boost Controller | DGQ10 | TPS40210DGQ | TI | 26780 |

Notes:

1. These assemblies are ESD sensitive, ESD precautions shall be observed.
2. These assemblies must be clean and free from flux and all contaminants.
   Use of no clean flux is not acceptable.
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
4. Ref designators marked with an asterisk ('**') cannot be substituted.
   All other components can be substituted with equivalent MFG's components.

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